

Surface Mount ESD Capability Rectifiers

eSMP® Series



DO-220AA (SMP)

FEATURES

- Very low profile - typical height of 1.0 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- Typical I_R less than 0.1 μ A
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C



RoHS
COMPLIANT
HALOGEN
FREE

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	0.7 A
V_{RRM}	100 V, 200 V, 400 V, 600 V
I_R	5 μ A
V_F at $I_F = 1.0$ A	0.865 V
T_J max.	175 °C
Package	DO-220AA (SMP)
Diode variations	Single die

MECHANICAL DATA

Case: DO-220AA (SMP)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes the cathode end

TYPICAL APPLICATIONS

General purpose, polarity protection, and rail-to-rail protection in consumer applications.

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	SE07PB	SE07PD	SE07PG	SE07PJ	UNIT
Device marking code		07B	07D	07G	07J	
Max. repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V
Average forward current	$I_{F(AV)}$	1.0				A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	20				A
Operating junction and storage temperature range	T_J, T_{STG}	- 55 to + 175				°C

ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	MAX.	UNIT	
Max. instantaneous forward voltage	$I_F = 0.7$ A	V_F (1)	$T_A = 25$ °C	0.965	1.05	V
			$T_A = 125$ °C	0.865	0.95	
Max. reverse current	Rated V_R	I_R (2)	$T_A = 25$ °C	-	5.0	μ A
			$T_A = 125$ °C	3.7	50	
Typical junction capacitance	4.0 V, 1 MHz	C_J	5.0	-	pF	

Notes

(1) Pulse test: 300 μ s pulse width, 1 % duty cycle

(2) Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	SE07PB	SE07PD	SE07PG	SE07PJ	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	105				$^\circ\text{C/W}$
	$R_{\theta JL}^{(1)}$	25				
	$R_{\theta JC}^{(1)}$	30				

Note

(1) Thermal resistance from junction to ambient and junction to lead mounted on PCB with 5.0 mm x 5.0 mm copper pad areas. $R_{\theta JL}$ - is measured at the terminal of cathode band. $R_{\theta JC}$ is measured at the top center of the body.

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
JESD22-A114	Human body model (contact mode)	$C = 100\text{ pF}$, $R = 1.5\text{ k}\Omega$	V_C	3B	$> 8\text{ kV}$
JESD22-A115	Machine model (contact mode)	$C = 200\text{ pF}$, $R = 0\text{ }\Omega$		C	$> 400\text{ V}$
IEC 61000-4-2 (2)	Human body model (contact mode)	$C = 150\text{ pF}$, $R = 330\text{ }\Omega$		4	$> 8\text{ kV}$
	Human body model (air-discharge mode) (1)	$C = 150\text{ pF}$, $R = 330\text{ }\Omega$		4	$> 15\text{ kV}$

Notes

(1) Immunity to IEC 61000-4-2 air discharge mode has a typical performance $> 30\text{ kV}$

(2) System ESD standard

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE07PJ-M3/84A	0.024	84A	3000	7" diameter plastic tape and reel
SE07PJ-M3/85A	0.024	85A	10 000	13" diameter plastic tape and reel

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

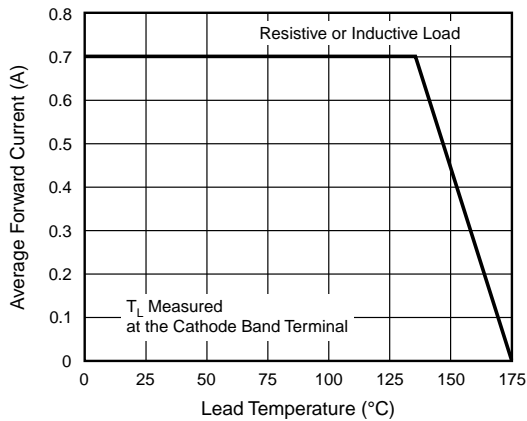


Fig. 1 - Max. Forward Current Derating Curve

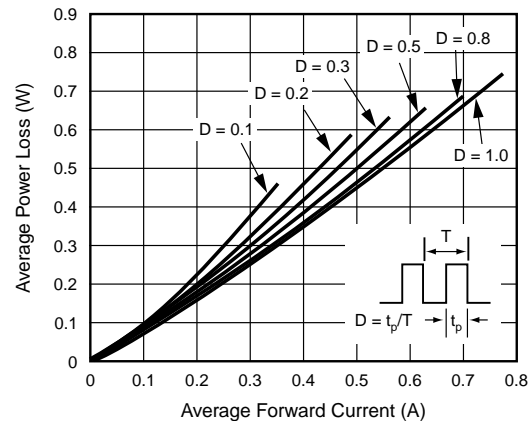


Fig. 2 - Forward Power Loss Characteristics

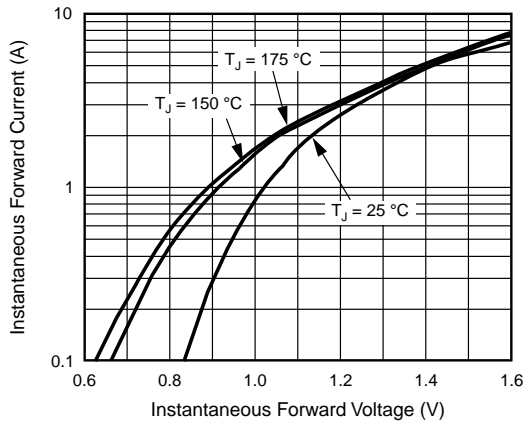


Fig. 3 - Typical Instantaneous Forward Characteristics

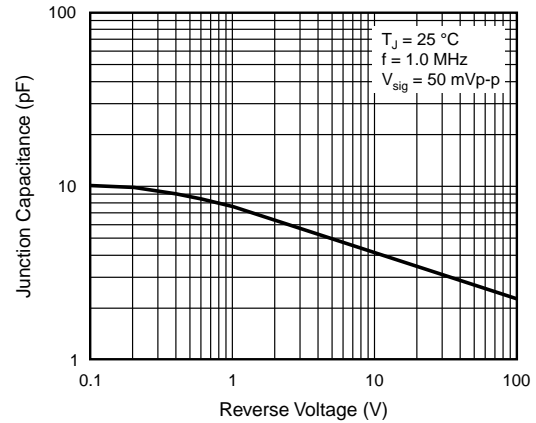


Fig. 5 - Typical Junction Capacitance

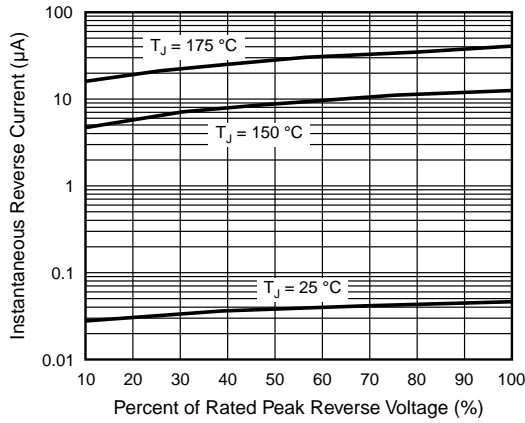


Fig. 4 - Typical Reverse Leakage Characteristics

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-220AA (SMP)

